Product Preview

Single-Phase Voltage Regulator with SVID Interface for Computing Applications

High Switching Frequency, High Efficiency, Integrated Power MOSFETs

The NCP81109F, a single-phase synchronous buck regulator, integrates power MOSFETs to provide a high-efficiency and compact-footprint power management solution for new generation computing CPUs. The device is able to deliver up to 14 A TDC output current on an adjustable output with SVID interface. Operating in high switching frequency up to 1.2 MHz allows employing small size inductors and capacitors while maintaining high efficiency due to integrated solution with high performance power MOSFETs. Current-mode RPM control with feedforward from both input power supply and output voltage ensures stable operation over wide operation condition. The NCP81109F is in a QFN48 6 x 6 mm package.

Features

- Meets Intel® Server Specifications
- 5 V to 20 V Input Voltage Range
- 1.0 V/1.5 V Fixed Boot Voltage
- Adjustable Output Voltage with SVID Interface
- Integrated Gate Driver and Power MOSFETs
- Up to 14 A TDC Output Current
- 500 kHz ~ 1.2 MHz Switching Frequency
- Current-Mode RPM Control
- Programmable SVID Address and ICCMax
- Programmable DVID Feed-Forward to Support Fast DVID
- Feedforward Operation for Input Supply Voltage and Output Voltage
- Output Over-Voltage and Under-Voltage Protections
- External Current Limitation Programming with Inductor Current Sense
- QFN48, 6 x 6 mm, 0.4 mm Pitch Package
- This is a Pb–Free Device

Typical Applications

• Server Applications

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.



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NCP81109	9F = Specific Device Code
А	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
G	= Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NCP81109FMNTXG	QFN48 (Pb–Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.



Figure 2. Typical Application Circuit



Figure 3. Functional Block Diagram

PIN DESCRIPTION

Pin	Name	Туре	Description
1	VRHOT#	Logic Output	VR HOT. Logic low output represents over temperature.
2	SDIO	Logic Bidirectional	Serial Data IO Port. Data port of SVID interface.
3	ALERT#	Logic Output	ALERT. Open-drain output. Provides a logic low valid alert signal of SVID interface.
4	SCLK	Logic Input	Serial Clock. Clock input of SVID interface.
5, 32, 49	GND	Analog Ground	Analog Ground. Ground of internal control circuits. Must be connected to the system ground.
6	VRRDY	Logic Output	Voltage Regulator Ready. Open-drain output. Provides a logic high valid power good output signal, indicating the regulator's output is in regulation window.
7, 11–17, 50	VIN	Power Input	Power Supply Input. These pins are the power supply input pins of the device, which are connected to drain of internal high-side power MOSFET. 22 μ F or more ceramic capacitors must bypass this input to power ground. The capacitors should be placed as close as possible to these pins.
8	BST	Power Bidirectional	Bootstrap. Provides bootstrap voltage for the high–side gate driver. A 0.1 μ F ~ 1 μ F ceramic capacitor is required from this pin to SW (pin 10). A 1 – 2 Ω resistor may be employed in series with the BST cap to reduce switching noise and ringing when needed.
9	GH	Analog Output	Gate of High-Side MOSFET. Directly connected with the gate of the high-side power MOSFET.
10	SW	Power Return	Switching Node. Provides a return path for integrated high-side gate driver. It is internally connected to source of high-side MOSFET.
18, 25–29, 51	SW	Power Output	Switch Node. Pins to be connected to an external inductor. These pins are interconnection between internal high-side MOSFET and low-side MOSFET.
19–24	PGND	Power Ground	Power Ground. These pins are the power supply ground pins of the device, which are connected to source of internal low-side power MOSFET. Must be connected to the system ground.
30	GL	Analog Output	Gate of Low-Side MOSFET. Directly connected with the gate of the low-side power MOSFET.
31	VBOOT	Analog Input	Boot-Up Voltage. A resistor from this pin to ground programs SVID address.
33	VCCP	Analog Power	Voltage Supply of Gate Driver. Power supply input pin of internal gate driver. A 4.7 μ F or larger ceramic capacitor bypasses this input to ground. This capacitor should be placed as close as possible to this pin.
34	TSENSE	Analog	Temperature Sense. An external temperature sense network is connected to this pin.
35	IMAX	Analog Input	Current Maximum. A resistor from this pin to ground programs IMAX.
36	IOUT	Analog Output	OUT Current Monitor. Provides output signal representing output current by connecting a resistor from this pin to ground. Shorting this pin to ground disables IMON function.
37	ILIM	Analog Output	Limit of Current. A resistor from this pin to CSCOMP programs over-current threshold with inductor current sense.
38	CSCOMP	Analog Output	Current Sense COMP. Output pin of current sense amplifier.
39	CSSUM	Analog Input	Current Sense SUM. Inverting input of current sense amplifier.
40	CSREF	Analog Input	Current Sense Reference. Non-Inverting input of current sense amplifier.
41	FREQ	Analog Input	Frequency. A resistor from this pin to ground programs switching frequency.
42	COMP	Analog	Compensation. Output pin of error amplifier.
43	FB	Analog Input	Feedback. Inverting input to error amplifier.
44	DIFFOUT	Analog Output	Differential Amplifier Output. Output pin of differential voltage sense amplifier.
45	VSN	Analog Input	Voltage Sense Negative Input. Inverting input of differential voltage sense amplifier. It is also used for DVID feed forward function with an external resistor.
	1	1	

PIN DESCRIPTION

Pin	Name	Туре	Description
47	VCC	Analog Power	Voltage Supply of Controller. Power supply input pin of control circuits. A 1 μF or larger ceramic capacitor bypasses this input to ground. This capacitor should be placed as close as possible to this pin.
48	EN	Logic Input	Enable. Logic high enables the device and logic low makes the device in standby mode.

MAXIMUM RATINGS

		Va		
Rating	Symbol	Min	Max	Unit
Power Supply Voltage to PGND	V _{VIN}		30	V
Switch Node to PGND	V _{SW}		30	V
Analog Supply Voltage to GND	V _{CC,} V _{CCP}	-0.3	6.5	V
BST to PGND	BST_PGND	-0.3	33 38 (<50 ns)	V
BST to SW	BST_SW	-0.3	6.5	V
GH to SW	GH	-0.3 -2 (<200 ns)	BST+0.3	V
GL to GND	GL	-0.3 -2 (<200 ns)	VCCP+0.3	V
VSN to GND	VSN	-0.3	0.3	V
IOUT	IOUT	-0.3	2.5	V
PGND to GND	PGND	-0.3	0.3	V
Other Pins		-0.3	VCC+0.3	V
Latch up Current: (Note 1) All pins, except digital pins Digital pins	ILU	-100 -10	100 10	mA
Operating Junction Temperature Range	TJ	-10	125	°C
Operating Ambient Temperature Range	T _A	-10	100	°C
Storage Temperature Range	T _{STG}	-40	150	°C
Thermal Resistance Junction to Board (Note 2)	R _{θJB}	8.2		°C/W
Thermal Resistance Junction to Ambient (Note 2)	R _{θJA}	21.8		°C/W
Power Dissipation at $T_A = 25^{\circ}C$ (Note 3)	PD	4.59		W
Moisture Sensitivity Level (Note 4)	MSL	(-	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Latch up Current per JEDEC standard: JESD78 class II.

2. The thermal resistance values are dependent of the internal losses split between devices and the PCB heat dissipation. This data is based on a typical operation condition with a 4-layer FR-4 PCB board, which has two, 1-ounce copper internal power and ground planes and 2-ounce copper traces on top and bottom layers with approximately 80% copper coverage. No airflow and no heat sink applied (reference EIA/JEDEC 51.7). It also does not account for other heat sources that may be present on the PCB next to the device in question (such as inductors, resistors etc.)

The maximum power dissipation (PD) is dependent on input voltage, output voltage, output current, external components selected, and PCB layout. The reference data is obtained based on T_{JMAX} = 125°C and R_{0JA} = 21.8°C/W.

4. Moisture Sensitivity Level (MSL): 3 per IPC/JEDEC standard: J-STD-020D.1.

ELECTRICAL CHARACTERISTICS (VIN = 12 V, V _{CC} = V _{CCP} = 5 V, V _{OUT} = 1.0 V, typical values are referenced to T _J = 25°C, Min	
and Max values are referenced to T_J from -10° C to 100°C. unless otherwise noted.)	

Characteristics	Test Conditions	Symbol	Min	Тур	Max	Unit
SUPPLY VOLTAGE					-	
Supply Voltage V _{IN} Range	(Note 5)	V _{IN}		12		V
Supply Voltage V _{CC} Range	(Note 5)	V _{CC}	4.75	5	5.25	V
Supply Voltage V _{CCP} Range	(Note 5)	V _{CCP}	4.75	5	5.25	V
SUPPLY VOLTAGE MONITOR			-		-	
V _{IN} UVLO	Falling Threshold	V _{INUV-}	3.0	3.25	3.5	V
	Hysteresis	V _{INHYS}		650	-	mV
V _{CC} UVLO	Falling Threshold	V _{CCUV-}	3.8	4.08	-	V
	Rising Threshold	V _{CCUV+}	-	4.34	4.5	V
	Hysteresis	V _{CCHYS}	-	260	-	mV
SUPPLY CURRENT	•					
V _{IN} Quiescent Supply Current (Power MOSFETs)	EN high, no load, PS0,1,2 Modes EN high, no load, PS3 Mode EN high, PS4 Mode (Note 6)	Ι _Q	- - -	1.5 1.5 -	3 3 1	mA mA μA
V _{IN} Shutdown Current	EN low (Note 6)	I _{SD}	-	-	1	μΑ
V _{CC} Quiescent Supply Current (Controller)	EN high, no load, PS0,1,2 Modes EN high, no load, PS3 Mode EN high, PS4 Mode (Note 6)	IQCC	- - -	8.0 7.5 170	12 12 194	mA mA μA
V _{CC} Shutdown Current	EN low (Note 6)	I _{SDCC}	-	-	90	μΑ
V _{CCP} Quiescent Supply Current (Gate Driver)	EN high, no load, PS0,1,2 Modes EN high, no load, PS3 Mode EN high, PS4 Mode	IQCCP	- - -	0.7 0.7 -	1.25 1.25 2	mA mA μA
V _{CCP} Shutdown Current	EN low	I _{SDCCP}	-	-	2	μΑ
OUTPUT VOLTAGE						
Output Voltage Range	(Note 5)	V _{OUT}	0	-	2.3	V
REGULATION ACCURACY						
System Voltage Accuracy	0.5 V < DAC < 1.52 V 0.25 V < DAC < 0.495 V		-8 -10		8 10	mV mV
DVID						
Fast Slew Rate	Default	FSR		14		mV/μs
Soft Start Slew Rate		SSSR		FSR/4		mV/μs
Slow Slew Rate		SSR		FSR/2 <u>FSR/4</u> (default) FSR/8 FSR/16		mV/μs
DIFFERENTIAL VOLTAGE-SENSE	AMPLIFIER	-	-	•	•	
DC Gain	VSP-VSN = 0.5 V to 2.3 V	GAIN_DVA		1.0		V/V
–3 dB Gain Bandwidth	CL = 20 pF to GND, RL = 10 k Ω to GND (Note 5)	BW_DVA		10		MHz
VSP Input Voltage Range	(Note 5)	VSP	-0.3	-	3.0	V
VSN Input Voltage Range	(Note 5)	VSN	-0.3	-	0.3	V
		+	1	1		1

5. Guaranteed by design, not tested in production. 6. $T_J = 25^{\circ}C$.

Input Bias Current

VSP,CSREF = 1.3 V

-15 -100

I_{VSP} I_{VSN} 15 100

μA nA

ELECTRICAL CHARACTERISTICS (V _{IN} = 12 V, V _{CC} = V _{CCP} = 5 V, V _{OUT} = 1.0 V, typical values are referenced to T _J = 25°C, Min	
and Max values are referenced to T_J from -10° C to 100° C. unless otherwise noted.)	

Characteristics	Test Conditions	Symbol	Min	Тур	Max	Unit
DIFFERENTIAL CURRENT-SENSE A	MPLIFIER					
DC Gain	(Note 5)	GAIN_DCA		80		dB
–3dB Gain Bandwidth	CL = 20 pF to GND, RL = 10 k Ω to GND (Note 5)	BW_DCA		10		MHz
Input Offset Voltage		V _{OS_CS}	-300	-	300	μV
Input Bias Current	CSSUM = CSREF = 1.2 V	I _{CSSUM} I _{CSREF}	-7.5 -10		7.5 10	nA μA
ERROR AMPLIFIER	•	•	•			
DC Gain	CL = 20 pF to GND, RL = 10 k Ω to GND (Note 5)	GAIN_EA		80		dB
Unity Gain Bandwidth	CL = 20 pF to GND, RL = 10 k Ω to GND (Note 5)	BW_EA		20		MHz
Slew Rate		SR_EA		25		V/µs
Output Voltage Swing	Isource_EA = 2 mA	Vmax_EA	3.5	-	-	V
	Isink_EA = 2 mA	Vmin_EA	-	-	1	
FB Voltage		V _{FB}		1.3		V
Input Bias Current	VFB = 1.3 V	I _{FB}	-1.5		1.5	μA
SWITCHING FREQUENCY						
Normal Operation Frequency (Programmed by a resistor at FREQ pin)	(Note 5)	FSW	500		1200	kHz
FREQ Output Voltage		VFREQ	1.95	2.0	2.05	V
CONTROL LOGIC	·	•				
ENABLE Input High Voltage		VEN_H	0.8	-	-	V
ENABLE Input Low Voltage		VEN_L	-	-	0.3	V
ENABLE Input Hysteresis		VEN_HYS	-	300	-	mV
ENABLE Input Bias Current		IEN_BIAS	-		1.0	μΑ
SCLK, SDIO						
Input High Voltage		V _{IH}	0.65			V
Input Low Voltage		V _{IL}			0.45	V
Input Threshold Hysteresis		V _{HYS}		50		mV
Output High Voltage	(Note 5)	V _{OH}		1.05		V
Output Low Voltage	SDIO	V _{OL}			0.3	V
Buffer On Resistance (data line, ALERT#, and VR_HOT#)		R _{ON}	3.0		13	Ω
Input Leakage Current	Pin voltage between 0 and 1.05 V		-100		100	μΑ
Input Capacitance	Die capacitance only (Note 5)				4.0	pF
VR Clock to Data Delay	Time between SCLK rising edge and valid SDIO level (Note 5)	Тсо	4		8.3	ns
Setup Time	Time before SCLK falling (sampling) edge that SDIO level must be valid (Note 5)	Tsu	7			ns

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ELECTRICAL CHARACTERISTICS (VIN = 12 V, VCC = VCCP = 5 V, VOUT = 1.0 V, typical values are referenced to TJ = 25°C, Min
and Max values are referenced to T_J from -10° C to 100° C. unless otherwise noted.)

Characteristics	Test Conditions	Symbol	Min	Тур	Мах	Unit
SCLK, SDIO	I		-	-	-	
Hold Time	Time after SCLK falling edge that the SDIO level remains valid (Note 5)	Thld	14			ns
ALERT#						-
Output Low Voltage	I_ ALERT # = -4 mA		-	-	0.3	V
Output Leakage Current	High Impedance State, ALERT # = 3.3 V		-1.0	-	1.0	μΑ
VR_HOT#	· · ·					
Output Low Voltage	I_VRHOT# = -4 mA		-	-	0.3	V
Output Leakage Current	High Impedance State, VRHOT# = 3.3 V		-1.0	-	1.0	μA
TSENSE						
Alert# Assert Threshold				491		mV
Alert# De-assert Threshold				513		mV
VR_HOT# Assert Threshold				472	1	mV
VR_HOT# De-assert Threshold				494	1	mV
TSENSE Bias Current	V _{TSENSE} = 0.4 V		115	120	125	μA
VBOOT						-
Sensing Current	V _{VBOOT} = GND			10		μA
IMAX			•			
Sensing Current	V _{IMAX} = GND			10		μA
ADC	· · ·					
Voltage Range			0		2.0	V
Total Unadjusted Error (TUE)			-1		1	%
Differential Nonlinearity (DNL)	8-bit				1	LSB
Power Supply Sensitivity				±1		%
Conversion Time				30		μs
Round Robin				90		μs
VR_READY (VRRDY Output)					1	
Rise Time	External 1 k Ω pull–up to 3.3 V, CTOT = 45 pF, Δ Vo = 10% to 90%			100		ns
Fall Time	External 1 k Ω pull–up to 3.3 V, CTOT = 45 pF, Δ Vo = 90% to 10%			10		ns
Output Voltage at Power–Up	Pulled up to 5 V via 2 k Ω		-	-	1.0	V
VR_READY Delay (Rising)	DAC = Target to VR_READY			50		μs
VR_READY Delay (Falling)	From OCP or OVP			5		μs
VRRDY Pin Low Voltage	Voltage at VRRDY pin with 4 mA sink current	VPG_L	-	-	0.3	V
VRRDY Pin Leakage Current	VRRDY = 5 V	PG_LK	-1.0	-	1.0	μA
OVER VOLTAGE PROTECTION	· · ·		•			
Absolute Over Voltage Threshold During Soft-Start			2.8	2.9	3.0	V

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ELECTRICAL CHARACTERISTICS (V _{IN} = 12 V, V _{CC} = V _{CCP} = 5 V, V _{OUT} = 1.0 V, typical values are referenced to T _J = 25°C, Min
and Max values are referenced to T_J from -10° C to 100° C. unless otherwise noted.)

Characteristics	Test Conditions	Symbol	Min	Тур	Max	Unit
OVER VOLTAGE PROTECTION	-					
Over Voltage Threshold Above DAC	VSP rising		350	400	425	mV
Over Voltage Delay	VSP rising to GH low			50		ns
UNDER VOLTAGE PROTECTION						
Under Voltage Threshold Below DAC	VSP falling		250	300	350	mV
Under-voltage Delay				5		μs
OVER CURRENT PROTECTION						
ILIM Threshold Current (OCP shutdown after 50 μs delay)		ILIMTH_SLOW	9.0	10.0	11.0	μA
ILIM Threshold Current (immediate OCP shutdown)		I _{LIMTH_FAST}	13.5	15.0	16.5	μA
ΙΟυΤ ΟυΤΡυΤ						
Current Gain	(IOUTCURRENT) / (ILIMCURRENT); RILIM = 20 k Ω ; RIOUT = 5.0 k Ω ; DAC = 0.8 V, 1.25 V, 1.52 V		9.5	10	10.5	A/A
Input Referred Offset Voltage	ILIM – CSREF		-2.0	-	2.0	mV
Output Source Current	ILIM sink current = 80 μA			800		μA
HIGH-SIDE MOSFET						
Drain-to-Source ON Resistance	VGS = 4.5 V, ID = 10 A	R _{ON_H}	-	8.0	-	mΩ
LOW-SIDE MOSFET						
Drain-to-Source ON Resistance	VGS = 4.5 V, ID = 10 A	R _{ON_L}	-	4.0	-	mΩ
HIGH-SIDE GATE DRIVE						
Pull-High Drive ON Resistance	$V_{BST} - V_{SW} = 5 V$	R _{DRV_HH}	-	1.2	2.8	Ω
Pull-Low Drive ON Resistance	$V_{BST} - V_{SW} = 5 V$	R _{DRV_HL}	-	0.8	2.0	Ω
GH Propagation Delay Time	From GL falling to GH rising	$T_{GH_{d}}$		15		ns
LOW-SIDE GATE DRIVE						
Pull-High Drive ON Resistance	$V_{CCP} - V_{PGND} = 5 V$	R _{DRV_LH}	-	0.9	2.8	Ω
Pull-Low Drive ON Resistance	V _{CCP} – V _{PGND} = 5 V	R _{DRV_LL}	-	0.4	1.25	Ω
GL Propagation Delay Time	From GH falling to GL rising	T _{GL_d}		10		ns
SW to PGND RESISTANCE						
SW to PGND Pull-Down Resistance	(Note 5)	R _{SW}	-	1.88	-	kΩ
BOOTSTRAP RECTIFIER SWITCH						
On Resistance	EN = L or EN = H and DRVL = H	R _{on_BST}	5	13	20	Ω

5. Guaranteed by design, not tested in production. 6. $T_J = 25^{\circ}C$.



NOTE: Timing is referenced to the 90% and 10% points, unless otherwise noted.





Figure 5. Timing Diagram of Start Up

Table 1. START-UP AND ENABLE TIMINGS

			Values		
Symbol	Description	Min	Тур	Max	Note
ТА	Non-zero Vboot Case: start of Vboot ramp Zero Vboot Case: Controller ready accept SVID command			2.5 ms	Complete all internal analog and digital configurations and reset protocols dur- ing TA. May be disclosed to CPU through register 2Dh.
ТВ	Vboot ramp time	Depends on Slew rate		w rate	When Vboot > 0 V, the VR is to slew at the default Slow rate of FAST/4
тс	Completion of Vboot ramp or initial SetVID ramp to assertion of associated VR_READY	0 µs		6 μs	



Table 2. STATE TRUTH TABLE

STATE	VR_RDY Pin	Error AMP Comp Pin	OVP & UVP	Method of Reset
POR 0 < VCC < UVLO	N/A	N/A	N/A	
Disabled EN < threshold UVLO > threshold	Low	Low	Disabled	
Start up Delay & Calibration EN > threshold UVLO > threshold	Low	Low	Disabled	
Soft Start EN > threshold UVLO > threshold	Low	Operational	Active / No latch	
Normal Operation EN > threshold UVLO > threshold	High	Operational	Active / Latching	N/A
Over Voltage	Low	N/A	DAC + 400 mV	
Over Current	Low	Operational	Last DAC Code	
VID Code = 00h	Low: if Reg34h:bit0 = 0; High:if Reg34h:bit0 = 1	Clamped at 0.9 V	Disabled	

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
0	0	0	0	0	0	0	0	OFF	00
0	0	0	0	0	0	0	1	0.25000	01
0	0	0	0	0	0	1	0	0.25500	02
0	0	0	0	0	0	1	1	0.26000	03
0	0	0	0	0	1	0	0	0.26500	04
0	0	0	0	0	1	0	1	0.27000	05
0	0	0	0	0	1	1	0	0.27500	06
0	0	0	0	0	1	1	1	0.28000	07
0	0	0	0	1	0	0	0	0.28500	08
0	0	0	0	1	0	0	1	0.29000	09
0	0	0	0	1	0	1	0	0.29500	0A
0	0	0	0	1	0	1	1	0.30000	0B
0	0	0	0	1	1	0	0	0.30500	0C
0	0	0	0	1	1	0	1	0.31000	0D
0	0	0	0	1	1	1	0	0.31500	0E
0	0	0	0	1	1	1	1	0.32000	0F
0	0	0	1	0	0	0	0	0.32500	10
0	0	0	1	0	0	0	1	0.33000	11
0	0	0	1	0	0	1	0	0.33500	12
0	0	0	1	0	0	1	1	0.34000	13
0	0	0	1	0	1	0	0	0.34500	14
0	0	0	1	0	1	0	1	0.35000	15
0	0	0	1	0	1	1	0	0.35500	16
0	0	0	1	0	1	1	1	0.36000	17
0	0	0	1	1	0	0	0	0.36500	18
0	0	0	1	1	0	0	1	0.37000	19
0	0	0	1	1	0	1	0	0.37500	1A
0	0	0	1	1	0	1	1	0.38000	1B
0	0	0	1	1	1	0	0	0.38500	1C
0	0	0	1	1	1	0	1	0.39000	1D
0	0	0	1	1	1	1	0	0.39500	1E
0	0	0	1	1	1	1	1	0.40000	1F
0	0	1	0	0	0	0	0	0.40500	20
0	0	1	0	0	0	0	1	0.41000	21
0	0	1	0	0	0	1	0	0.41500	22
0	0	1	0	0	0	1	1	0.42000	23
0	0	1	0	0	1	0	0	0.42500	24
0	0	1	0	0	1	0	1	0.43000	25
0	0	1	0	0	1	1	0	0.43500	26
0	0	1	0	0	1	1	1	0.44000	27
0	0	1	0	1	0	0	0	0.44500	28
0	0	1	0	1	0	0	1	0.45000	29
0	0	1	0	1	0	1	0	0.45500	28 2A
0	0	1	0	1	0	1	1	0.46000	2B
0	0	1	0	1	1	0	0	0.46500	2D 2C
0	0	1	0	1	1	0	1	0.47000	20 2D
0	0	1	0	1	1	1	0	0.47500	25 2E
0	0	1	0	1	1	1	1	0.48000	2E 2F

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
0	0	1	1	0	0	0	0	0.48500	30
0	0	1	1	0	0	0	1	0.49000	31
0	0	1	1	0	0	1	0	0.49500	32
0	0	1	1	0	0	1	1	0.50000	33
0	0	1	1	0	1	0	0	0.50500	34
0	0	1	1	0	1	0	1	0.51000	35
0	0	1	1	0	1	1	0	0.51500	36
0	0	1	1	0	1	1	1	0.52000	37
0	0	1	1	1	0	0	0	0.52500	38
0	0	1	1	1	0	0	1	0.53000	39
0	0	1	1	1	0	1	0	0.53500	ЗA
0	0	1	1	1	0	1	1	0.54000	3B
0	0	1	1	1	1	0	0	0.54500	3C
0	0	1	1	1	1	0	1	0.55000	3D
0	0	1	1	1	1	1	0	0.55500	3E
0	0	1	1	1	1	1	1	0.56000	3F
0	1	0	0	0	0	0	0	0.56500	40
0	1	0	0	0	0	0	1	0.57000	41
0	1	0	0	0	0	1	0	0.57500	42
0	1	0	0	0	0	1	1	0.58000	43
0	1	0	0	0	1	0	0	0.58500	44
0	1	0	0	0	1	0	1	0.59000	45
0	1	0	0	0	1	1	0	0.59500	46
0	1	0	0	0	1	1	1	0.60000	47
0	1	0	0	1	0	0	0	0.60500	48
0	1	0	0	1	0	0	1	0.61000	49
0	1	0	0	1	0	1	0	0.61500	4A
0	1	0	0	1	0	1	1	0.62000	4B
0	1	0	0	1	1	0	0	0.62500	4D 4C
0	1	0	0	1	1	0	1	0.63000	40 4D
0	1	0	0	1	1	1	0	0.63500	4D 4E
0	1	0	0	1	1	1	1	0.64000	4∟ 4F
0	1	0	1	0	0	0	0	0.64500	50
0	1	0	1	0	0	0	1	0.65000	50
0	1	0	1	0	0	1	0	0.65500	52
			1					0.66000	53
0	1	0	1	0	1	0	0	0.66500	54
0	1	0	1	0	1	0	1	0.67000	55
0	1	0	1	0	1	1	0	0.67500	56
0	1	0	1	0	1	1	1	0.68000	57
0	1	0	1	1	0	0	0	0.68500	58
0	1	0	1	1	0	0	1	0.69000	59
0	1	0	1	1	0	1	0	0.69500	5A
0	1	0	1	1	0	1	1	0.70000	5B
0	1	0	1	1	1	0	0	0.70500	5C
0	1	0	1	1	1	0	1	0.71000	5D
0	1	0	1	1	1	1	0	0.71500	5E
0	1	0	1	1	1	1	1	0.72000	5F

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
0	1	1	0	0	0	0	0	0.72500	60
0	1	1	0	0	0	0	1	0.73000	61
0	1	1	0	0	0	1	0	0.73500	62
0	1	1	0	0	0	1	1	0.74000	63
0	1	1	0	0	1	0	0	0.74500	64
0	1	1	0	0	1	0	1	0.75000	65
0	1	1	0	0	1	1	0	0.75500	66
0	1	1	0	0	1	1	1	0.76000	67
0	1	1	0	1	0	0	0	0.76500	68
0	1	1	0	1	0	0	1	0.77000	69
0	1	1	0	1	0	1	0	0.77500	6A
0	1	1	0	1	0	1	1	0.78000	6B
0	1	1	0	1	1	0	0	0.78500	6C
0	1	1	0	1	1	0	1	0.79000	6D
0	1	1	0	1	1	1	0	0.79500	6E
0	1	1	0	1	1	1	1	0.80000	6F
0	1	1	1	0	0	0	0	0.80500	70
0	1	1	1	0	0	0	1	0.81000	71
0	1	1	1	0	0	1	0	0.81500	72
0	1	1	1	0	0	1	1	0.82000	73
0	1	1	1	0	1	0	0	0.82500	74
0	1	1	1	0	1	0	1	0.83000	75
0	1	1	1	0	1	1	0	0.83500	76
0	1	1	1	0	1	1	1	0.84000	77
0	1	1	1	1	0	0	0	0.84500	78
0	1	1	1	1	0	0	1	0.85000	79
0	1	1	1	1	0	1	0	0.85500	7A
0	1	1	1	1	0	1	1	0.86000	7B
0	1	1	1	1	1	0	0	0.86500	7C
0	1	1	1	1	1	0	1	0.87000	7D
0	1	1	1	1	1	1	0	0.87500	7E
0	1	1	1	1	1	1	1	0.88000	7F
1	0	0	0	0	0	0	0	0.88500	80
1	0	0	0	0	0	0	1	0.89000	81
1	0	0	0	0	0	1	0	0.89500	82
1	0	0	0	0	0	1	1	0.90000	83
1	0	0	0	0	1	0	0	0.90500	84
1	0	0	0	0	1	0	1	0.91000	85
1	0	0	0	0	1	1	0	0.91500	86
1	0	0	0	0	1	1	1	0.92000	87
1	0	0	0	1	0	0	0	0.92500	88
1	0	0	0	1	0	0	1	0.93000	89
1	0	0	0	1	0	1	0	0.93500	8A
1	0	0	0	1	0	1	1	0.93500	8B
1	0	0	0	1	1	0	0	0.94000	80 80
1	0	0	0	1	1	0	1	0.94500	80 8D
	0	0	0			1	0	0.95500	8D 8E
1	U	U	U	1	1	I	U	0.9000	δĖ

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
1	0	0	1	0	0	0	0	0.96500	90
1	0	0	1	0	0	0	1	0.97000	91
1	0	0	1	0	0	1	0	0.97500	92
1	0	0	1	0	0	1	1	0.98000	93
1	0	0	1	0	1	0	0	0.98500	94
1	0	0	1	0	1	0	1	0.99000	95
1	0	0	1	0	1	1	0	0.99500	96
1	0	0	1	0	1	1	1	1.00000	97
1	0	0	1	1	0	0	0	1.00500	98
1	0	0	1	1	0	0	1	1.01000	99
1	0	0	1	1	0	1	0	1.01500	9A
1	0	0	1	1	0	1	1	1.02000	9B
1	0	0	1	1	1	0	0	1.02500	9C
1	0	0	1	1	1	0	1	1.03000	9D
1	0	0	1	1	1	1	0	1.03500	9E
1	0	0	1	1	1	1	1	1.04000	9F
1	0	1	0	0	0	0	0	1.04500	A0
1	0	1	0	0	0	0	1	1.05000	A1
1	0	1	0	0	0	1	0	1.05500	A2
1	0	1	0	0	0	1	1	1.06000	A3
1	0	1	0	0	1	0	0	1.06500	A4
1	0	1	0	0	1	0	1	1.07000	A5
1	0	1	0	0	1	1	0	1.07500	A6
1	0	1	0	0	1	1	1	1.08000	A7
	0	1	0	1	0	0	0	1.08500	A7 A8
1	0	1	0		0	0			
1				1			1	1.09000	A9
1	0	1	0	1	0	1	0	1.09500	AA
1	0	1	0	1	0	1	1	1.10000	AB
1	0	1	0	1	1	0	0	1.10500	AC
1	0	1	0	1	1	0	1	1.11000	AD
1	0	1	0	1	1	1	0	1.11500	AE
1	0	1	0	1	1	1	1	1.12000	AF
1	0	1	1	0	0	0	0	1.12500	B0
1	0	1	1	0	0	0	1	1.13000	B1
1	0	1	1	0	0	1	0	1.13500	B2
1	0	1	1	0	0	1	1	1.14000	B3
1	0	1	1	0	1	0	0	1.14500	B4
1	0	1	1	0	1	0	1	1.15000	B5
1	0	1	1	0	1	1	0	1.15500	B6
1	0	1	1	0	1	1	1	1.16000	B7
1	0	1	1	1	0	0	0	1.16500	B8
1	0	1	1	1	0	0	1	1.17000	B9
1	0	1	1	1	0	1	0	1.17500	BA
1	0	1	1	1	0	1	1	1.18000	BB
1	0	1	1	1	1	0	0	1.18500	BC
1	0	1	1	1	1	0	1	1.19000	BD
1	0	1	1	1	1	1	0	1.19500	BE
1	0	1	1	1	1	1	1	1.20000	BF

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
1	1	0	0	0	0	0	0	1.20500	C0
1	1	0	0	0	0	0	1	1.21000	C1
1	1	0	0	0	0	1	0	1.21500	C2
1	1	0	0	0	0	1	1	1.22000	C3
1	1	0	0	0	1	0	0	1.22500	C4
1	1	0	0	0	1	0	1	1.23000	C5
1	1	0	0	0	1	1	0	1.23500	C6
1	1	0	0	0	1	1	1	1.24000	C7
1	1	0	0	1	0	0	0	1.24500	C8
1	1	0	0	1	0	0	1	1.25000	C9
1	1	0	0	1	0	1	0	1.25500	CA
1	1	0	0	1	0	1	1	1.26000	СВ
1	1	0	0	1	1	0	0	1.26500	СС
1	1	0	0	1	1	0	1	1.27000	CD
1	1	0	0	1	1	1	0	1.27500	CE
1	1	0	0	1	1	1	1	1.28000	CF
1	1	0	1	0	0	0	0	1.28500	D0
1	1	0	1	0	0	0	1	1.29000	D1
1	1	0	1	0	0	1	0	1.29500	D2
1	1	0	1	0	0	1	1	1.30000	D3
1	1	0	1	0	1	0	0	1.30500	D4
1	1	0	1	0	1	0	1	1.31000	D5
1	1	0	1	0	1	1	0	1.31500	D6
1	1	0	1	0	1	1	1	1.32000	D7
1	1	0	1	1	0	0	0	1.32500	D8
1	1	0	1	1	0	0	1	1.33000	D9
1	1	0	1	1	0	1	0	1.33500	DA
1	1	0	1	1	0	1	1	1.34000	DB
1	1	0	1	1	1	0	0	1.34500	DC
		0		1		0		1.34300	DD
1	1	0	1	1	1	1	1		DE
1	1	0	1	1	1	1	1	1.35500	DE
								1.36000	
1	1	1	0	0	0	0	0	1.36500	E0
1	1	1	0	0	0	0	1	1.37000	E1
1	1	1	0	0	0	1	0	1.37500	E2
1	1	1	0	0	0	1	1	1.38000	E3
1	1	1	0	0	1	0	0	1.38500	E4
1	1	1	0	0	1	0	1	1.39000	E5
1	1	1	0	0	1	1	0	1.39500	E6
1	1	1	0	0	1	1	1	1.40000	E7
1	1	1	0	1	0	0	0	1.40500	E8
1	1	1	0	1	0	0	1	1.41000	E9
1	1	1	0	1	0	1	0	1.41500	EA
1	1	1	0	1	0	1	1	1.42000	EB
1	1	1	0	1	1	0	0	1.42500	EC
1	1	1	0	1	1	0	1	1.43000	ED
1	1	1	0	1	1	1	0	1.43500	EE
1	1	1	0	1	1	1	1	1.44000	EF

VID7	VID6	VID5	VID4	VID3	VID2	VID1	VID0	Voltage (V)	HEX
1	1	1	1	0	0	0	0	1.44500	F0
1	1	1	1	0	0	0	1	1.45000	F1
1	1	1	1	0	0	1	0	1.45500	F2
1	1	1	1	0	0	1	1	1.46000	F3
1	1	1	1	0	1	0	0	1.46500	F4
1	1	1	1	0	1	0	1	1.47000	F5
1	1	1	1	0	1	1	0	1.47500	F6
1	1	1	1	0	1	1	1	1.48000	F7
1	1	1	1	1	0	0	0	1.48500	F8
1	1	1	1	1	0	0	1	1.49000	F9
1	1	1	1	1	0	1	0	1.49500	FA
1	1	1	1	1	0	1	1	1.50000	FB
1	1	1	1	1	1	0	0	1.50500	FC
1	1	1	1	1	1	0	1	1.51000	FD
1	1	1	1	1	1	1	0	1.51500	FE
1	1	1	1	1	1	1	1	1.52000	FF

Table 4. SUPPORTED REGISTERS

Index	Name	Description	Access	Default
00h	Vendor ID	Uniquely identifies the VR vendor. The vendor ID assigned by Intel to ON Semiconductor is 0x1Ah	R	1Ah
01h	Product ID	Uniquely identifies the VR product. The VR vendor assigns this number.	R	19h
02h	Product Revision	Uniquely identifies the revision or stepping of the VR control IC. The VR vendor assigns this data.	R	00h
03h	Date code ID		R	00h
05h	Protocol ID	Identifies the SVID Protocol the controller supports	R	01h
06h	Capability	Informs the Master of the controller's Capabilities, 1 = supported, 0 = not supported Bit 7 = lout_format. Bit 7 = 0 when 1A = 1LSB of Reg 15h. Bit 7 = 1 when Reg 15 FFh = loc_Max. Default = 1 Bit 6 = ADC Measurement of Temp Supported = 1 Bit 5 = ADC Measurement of Pin Supported = 0 Bit 4 = ADC Measurement of Vin Supported = 0 Bit 3 = ADC Measurement of Iin Supported = 0 Bit 2 = ADC Measurement of Pout Supported = 1 Bit 1 = ADC Measurement of Vout Supported = 1 Bit 0 = ADC Measurement of lout Supported = 1	R	D7h
10h	Status_1	Data register read after ALERT# signal is asserted. Conveying the status of the VR.	R	00h
11h	Status_2	Data register showing optional status_2 data.	R	00h
12h	Temp zone	Data register showing temperature zones the system is operating in	R	00h
15h	I_out	8 bit binary word ADC of current. This register reads 0xFF when the IOUT(A) pin voltage is 2 V. The IOUT(A) voltage should be scaled with an external resister to ground such that a load equal to Icc_Max generates a 2 V signal.	R	01h
16h	V_out	8 bit binary ADC of output voltage between VSP and VSN. LSB size is 8 mV	R	01h
17h	VR_Temp	8 bit binary word ADC of voltage. Binary format in deg C, IE 100C = 64h. A value of 00h indicates this function is not supported	R	01h
18h	P_out	8 bit binary word representative of output power. The output voltage is multiplied by the output current value and the result is stored in this register. A value of 00h in- dicates this function is not supported	R	01h
1Ch	Status 2 Last read	When the status 2 register is read its contents are copied into this register. The format is the same as the Status 2 Register.	R	00h
21h	lcc_Max	Data register containing the lcc_Max. The value is measured on the ICCMAX pin on power up and placed in this register. From that point on the register is read only.	R	00h
22h	Temp_Max	Data register containing the max temperature and the level VR_hot asserts. This value defaults to 100°C and programmable over the SVID Interface	R/W	64h
24h	SR_fast	Slew Rate for SetVID_fast commands. Binary format in mV/µs.	R	32h
25h	SR_slow	Slew Rate for SetVID_slow commands. It is 4X slower than the SR_fast rate. Binary format in $mV/\mu s$	R	0Ch
26h	Vboot	The NCP81109F ramps to Vboot and holds at Vboot until it receives a new SVID SetVID command to move to a different voltage. Default value = 0 V.	R	00h
2Ah	SR_Slow selector	Fast_SR/2 Fast_SR/4: default Fast_SR/8 Fast_SR/16	R/W	02h
2Bh	PS4 exit latency	Reflects the latency of exiting PS4 state. The exit latency is defined as the time duration, in μs , from the ACK of the SETVID Slow/Fast command to the output voltage beginning to ramp	R	00h
2Ch	PS3 exit latency	Reflects the latency of exiting PS3 state. The exit latency is defined as the time duration, in μ s, from the ACK of the SETVID/SetPS command until the controller is capable of supplying max current of the command PS state.	R	00h
2Dh	EN to Ready for SVID command (TA)	Reflects the latency from enable assertion to the VR controller being ready to accept SVID commands.	R	00h

Table 4. SUPPORTED REGISTERS

Index	Name	Description	Access	Default
30h	Vout_Max	Programmed by master and sets the maximum VID the VR will support. If a higher VID code is received, the VR should respond with "not supported" acknowledge. VR 12 VID format.	RW	B5h
31h	VID setting	Data register containing currently programmed VID voltage. VID data format.	RW	00h
32h	Pwr State	Register containing the current programmed power state.	RW	00h
33h	Offset	Sets offset in VID steps added to the VID setting for voltage margining. Bit 7 is sign bit, 0 = positive margin, 1 = negative margin. Remaining 7 BITS are # VID steps for margin 2s complement. 00h = no margin 01h = +1 VID step 02h = +2 VID steps FFh = -1 VID step FEh = -2 VID steps.	RW	00h
34h	MultiVR Config			

DETAILED DESCRIPTION

General

The NCP81109F, a single-phase synchronous buck regulator, integrates power MOSFETs to provide a high-efficiency and compact-footprint power management solution for new generation computing CPUs. The device is able to deliver up to 14 A TDC output current on an adjustable output with SVID interface. Operating in high switching frequency up to 1.2 MHz allows employing small size inductors and capacitors while maintaining high efficiency due to integrated solution with high performance power MOSFETs. Current-mode RPM control with feedforward from both input power supply and output voltage ensures stable operation over wide operation condition.

Operation Modes

The NCP81109F implements PS0, PS1, PS2, PS3, and PS4 power operation modes as shown in Table 5.

Power Status	Operation Mode
PS0	Forced CCM mode – normal mode
PS1	Forced CCM mode – low power mode
PS2	Auto CCM/DCM mode – very low power mode
PS3	Auto CCM/DCM mode – ultra low power mode
PS4	Vout = 0, SVID active only

Current–Mode RPM Operation

The NCP81109F operates with the current-mode Ramp-Pulse-Modulation (RPM) scheme in PS0/1/2/3 operation modes. In forced CCM mode, the inductor current is always continuous and the device operates in quasi-fixed switching frequency, which has a typical value programmed by users through a resistor at pin FREQ. In auto CCM/DCM mode, the inductor current is continuous and the device operates in quasi-fixed switching frequency in medium and heavy load range, while the inductor current becomes discontinuous and the device automatically operates in PFM mode with an adaptive fixed on time and variable switching frequency in light load range.

Serial VID interface (SVID)

The NCP81109F supports Intel serial VID interface. It communicates with the microprocessor through three wires (SCLK, SDIO, ALERT#). SCLK, SDIO and ALERT# should be pulled high to CPU I/O voltage VTT (which is typically 1.0 to 1.1 V) using 55 Ω Resistors. The SVID bus will operate at a max frequency of 43 MHz. For NCP81109F, VID code change rate is controlled by the SVID interface with three options as shown in Table 6. All the supported registers are shown in Table 4.

Option	SVID Command Code	Feature	Register Address (Indicating the slew rate of VID code change)
SetVID_Fast	01h	selectable slew rate	24h
SetVID_Slow	02h	Fast_SR/2 Fast_SR/4: default Fast_SR/8 Fast_SR/16	25h
SetVID_Decay	03h	No control, VID code down	N/A

Table 6. REGISTERS FOR VID CODE CHANGE RATE

Start Up Sequence

A timing diagram of start-up sequence is shown in Figure 5, and timing parameters are shown in Table 1.

Boot Voltage and SVID Address

Table 7 shows two boot voltage options of 1.0 V and 1.5 V programmed by an external 1% resistor Rvboot from Vboot

pin to GND, which programs SVID address as well. Both values are set on power up and cannot be changed after the initial power up sequence is complete.

> Vboot (V) 1.0

Ryboot	,			
(Ω)	Min	Тур	Мах	Address
0	0	0	102	0x0
14.0k	102	140	180	0x1
22.1k	180	219	258	0x2
30.1k	258	301	344	0x3
39.2k	344	391	438	0x4

Table 7. BOOT VOLTAGE AND SVID ADDRESS CONFIGURATION

14.0k	102	140	180	0x1	1.0
22.1 k	180	219	258	0x2	1.0
30 .1k	258	301	344	0x3	1.0
39 .2k	344	391	438	0x4	1.0
48.7 k	438	484	531	0x5	1.0
57.6 k	531	578	625	0x6	1.0
68.1 k	625	676	727	0x7	1.0
78.7 k	727	781	836	0x8	1.0
88.7 k	836	894	953	0x0	1.5
100k	953	1007	1062	0x1	1.5
113k	1062	1125	1188	0x2	1.5
124k	1188	1250	1312	0x3	1.5
137k	1312	1378	1445	0x4	1.5
150k	1445	1511	1578	0x5	1.5
165k	1578	1648	1719	0x6	1.5
178k	1719	1789	1859	0x7	1.5
196k	1859	1950	-	0x8	1.5

Switching Frequency

Switching frequency is programmed by a resistor RFREQ to ground at the FREQ pin. The typical frequency range is from 500 kHz to 1.2 MHz. The FREQ pin provides approximately 2 V out and the source current is mirrored into the internal ramp generator. The switching frequency can be found in Figure 7 with a given R_{FREQ}. The frequency

shown in Figure 7 is under condition of 10 A output current at VID = 1 V. The frequency has a variation over VID voltage and loading current, which maintains similar output ripple voltage over different operation condition. Figure 8 shows frequency variations over the VID voltage range.



Figure 7. Switching Frequency vs. R_{FREQ}



Figure 8. Switching Frequency vs. VID Voltage

Remote Voltage Sense

A high performance differential amplifier is provided to accurately sense the output voltage of the regulator. The VSP and VSN inputs should be connected to the regulator's output voltage sense points. The output (DIFOUT) of the remote sense amplifier is a sum of the error voltage (between the output VSP–VSN and the DAC) and a 1.3 V DC bias.

$$V_{\text{DIFOUT}} = \left(V_{\text{VSP}} - V_{\text{VSN}}\right) + \left(1.3 \text{ V} - V_{\text{DAC}}\right) \quad (\text{eq. 1})$$

The DIFOUT signal then goes through a compensation network and into the inverting input (FB pin) of an error amplifier. The non-inverting input of the error amplifier is connected to the same 1.3 V used for the differential sense amplifier output bias.



Figure 9. Differential Current–Sense Circuit Diagram

Differential Current Sense

The differential current-sense circuit diagram is shown in Figure 9. An internally-used voltage signal Vcs, representing the inductor current level, is the voltage difference between CSREF and CSCOMP. The output side of the inductor is used to create a low impedance virtual ground. The current-sense amplifier actively filters and gains up the voltage applied across the inductor to recover the voltage drop across the inductor's DC resistance (DCR). RCS_NTC is placed close to the inductor to sense the temperature. This allows the filter time constant and gain to be a function of the Rth_NTC resistor and compensate for the change in the DCR with temperature. The DC gain in the current sensing loop is

$$G_{CS} = \frac{V_{CS}}{V_{DCR}} = \frac{V_{CSREF} - V_{CSCOMP}}{I_{OUT} \cdot DCR} = \frac{R_{CS}}{R_{CS3}}$$
(eq. 2)

Where

$$R_{CS} = R_{CS2} + \frac{R_{CS1} \cdot R_{CS_NTC}}{R_{CS1} + R_{CS_NTC}}$$
(eq. 3)

The values of Rcs1 and Rcs2 are set based on a 220k NTC thermistor and the temperature effect of the inductor and thus usually they should not need to be changed. The gain

Gcs can be adjusted by the value change of the Rcs3 resistor to provide about 100 mV in Vcs at full load.

In order to recover the inductor DCR voltage drop current signal, the pole frequency in the CSCOMP filter should be set equal to the zero from the output inductor, that means

$$C_{CS1} + C_{CS2} = \frac{L}{DCR \cdot R_{CS}}$$
 (eq. 4)

Ccs1 and Ccs2 are in parallel to allow for a fine tuning of the time constant using commonly available values.

Over Current Protection

The NCP81109F provides two different types of current limit protection. Current limits are programmed with a resistor RILIM between the CSCOMP pin and the ILIM pin. The current from the ILIM pin to this resistor is then compared to two internal currents (10 μ A and 15 μ A) corresponding to two different current limit thresholds ILIM and ILIM_Fast (150% of ILIM level). If the ILIM pin current exceeds the 10 μ A level, an internal latch-off timer starts. The controller shuts down if the fault is not removed after 50 μ s. If the current into the pin exceeds 15 μ A the controller will shut down immediately. To recover from an OCP fault the EN pin must be cycled low.

The value of RILIM can be designed using the following equation with a required over current protection threshold ILIM and a known current–sense network.

$$\begin{split} \mathsf{R}_{\mathsf{ILIM}} &= \frac{\mathsf{V}_{\mathsf{CS}} @ \mathsf{I}_{\mathsf{LIM}}}{10\,\mu} = \frac{\mathsf{R}_{\mathsf{CS}}}{\mathsf{R}_{\mathsf{CS3}}} \cdot \mathsf{I}_{\mathsf{LIM}_\mathsf{PK}} \cdot \mathsf{DCR} \cdot 10^5 \\ &= \frac{\mathsf{R}_{\mathsf{CS}}}{\mathsf{R}_{\mathsf{CS3}}} \cdot \left(\mathsf{I}_{\mathsf{LIM}} + \frac{\left(\mathsf{V}_{\mathsf{IN}} - \mathsf{V}_{\mathsf{OUT}}\right) \cdot \mathsf{V}_{\mathsf{OUT}}}{2 \cdot \mathsf{L} \cdot \mathsf{F}_{\mathsf{SW}} \cdot \mathsf{V}_{\mathsf{IN}}}\right) \cdot \mathsf{DCR} \cdot 10^5 \end{split}$$

ICC_MAX

The SVID interface conveys the platform ICC_MAX value to the CPU by register 21h. A resistor R_ICCMAX from the IMAX pin to ground programs this register at the time the part is enabled. A 10 μ A current is sourced from this pin to generate a voltage on the program resistor. The value of the register is 1A per LSB and is set by the equation below. The resistor value should be no less than 10 k.

$$ICC_MAX_{21h} = \frac{R_{ICCMAX} \cdot 10 \ \mu \cdot 64}{2} = R_{ICCMAX} \cdot 3.2 \cdot 10^{-4}$$
(eq. 6)

IOUT

The IOUT pin sources a current equal to the ILIM sink current gained by the IOUT Current Gain (10 typ.). The voltage of the IOUT pin is monitored by the internal A/D converter and should be scaled with an external resistor to ground such that a load equal to ICCMAX generates a 2 V signal on IOUT. A pull–up resistor to 5 V V_{CC} can be used to offset the IOUT signal positive if needed.

Input UVLO Protection

NCP81109F monitors supply voltages at the VCC pin and the VIN pins in order to provide under voltage protection. If either supply drops below its threshold, the controller will shut down the outputs. Upon recovery of the supplies, the controller reenters its startup sequence, and soft start begins.

Output Under-Voltage Protection

The output voltage is monitored by a dedicated differential amplifier. If the output falls below target by more than "Under Voltage Threshold below DAC–Droop", the UVL comparator sends the VR RDY signal low.

Output Over-Voltage Protection

During normal operation the output voltage is monitored at the differential inputs VSP and VSN. If the output voltage exceeds the DAC voltage by "Over Voltage Threshold above DAC", GH will be forced low, and GL will go high. After the OVP trips, the DAC ramps slowly down to zero to avoid a negative output voltage spike during shutdown. If the DAC+OVP Threshold drops below the output, GL will again go high, and will toggle between low and high as the output voltage follows the DAC+OVP Threshold down. When the DAC gets to zero, the GH will be held low and the GL will remain high. To reset the part, the EN pin must be cycled low. During soft–start, the OVP threshold is set to 2.9 V. This allows the controller to start up without false triggering the OVP.



Figure 10. Function of Over Voltage Protection

Temperature Sense and Thermal Alert

The NCP81109F provides an external temperature sense and a thermal alert in normal operation mode. The temperature sense and thermal alert circuit diagram is shown in Figure 11. A precision current ITSENSE is sourced out the output of the TSENSE pin to generate a voltage across the temperature sense network, which consists of a NTC thermistor R NTC (100 k Ω typ.), two resistors R COMP1 (0 Ω typ.) and R_COMP2 (8.2 k Ω typ.), and a filter capacitor C_Filter (0.1 µF typ.). The voltage on the temperature sense input is sampled by the internal A/D converter and then digitally converted to temperature and stored in SVID register 17h. Usually the thermistor is placed close to a hot spot like inductor or NCP81109F itself. A 100k NTC thermistor similar to the Murata NCP15WF104D03RC should be used. The NCP81109F

also monitors the voltage at the TSENSE pin and compares the voltage to internal thresholds and assert ALERT# or VRHOT# once it trips the thresholds. The DC voltage at TSENSE pin can be calculated by

$$V_{\text{TSENSE}} = I_{\text{TSENSE}} \cdot \left(R_{\text{COMP1}} + \frac{R_{\text{COMP2}} \cdot R_{\text{NTC}_{\text{T}}}}{R_{\text{COMP2}} + R_{\text{NTC}_{\text{T}}}} \right)$$
(eq. 8)

 R_{NTC_T} is the resistance of R_NTC at an absolute temperature T, which is obtained by

$$R_{NTC_T} = R_{NTC_T_0} \cdot \exp\left(B \cdot \left(\frac{1}{T} - \frac{1}{T_0}\right)\right)$$
(eq. 9)

where R_{NTC_T0} is a known resistance of R_NTC at an absolute temperature T₀, and B is the B-constant of R_NTC.



Figure 11. Temperature Sense and Thermal Alert Circuit Diagram

LAYOUT GUIDELINES

Electrical Layout Considerations

Good electrical layout is a key to make sure proper operation, high efficiency, and noise reduction. Electrical layout guidelines are:

- Power Paths: Use wide and short traces for power paths (such as VIN, VOUT, SW, and PGND) to reduce parasitic inductance and high-frequency loop area. It is also good for efficiency improvement.
- Power Supply Decoupling: The device should be well decoupled by input capacitors and input loop area should be as small as possible to reduce parasitic inductance, input voltage spike, and noise emission. Usually, a small low-ESL MLCC is placed very close to VIN and PGND pins.
- VCC Decoupling: Place decoupling caps as close as possible to the controller VCC and VCCP pins. The filter resistor at VCC pin should be not higher than 2.2 Ω to prevent large voltage drop.
- Switching Node: SW node should be a copper pour, but compact because it is also a noise source.
- Bootstrap: The bootstrap cap and an option resistor need to be very close and directly connected between pin 8 (BST) and pin 10 (SW). No need to externally connect pin 10 to SW node because it has been internally connected to other SW pins.
- Ground: It would be good to have separated ground planes for PGND and GND and connect the two planes at one point. Directly connect GND pin to the exposed pad and then connect to GND ground plane through vias.
- Voltage Sense: Use Kelvin sense pair and arrange a "quiet" path for the differential output voltage sense.
- **Current Sense:** Careful layout for current sensing is critical for jitter minimization, accurate current

limiting, and IOUT reporting. The filter cap from CSCOMP to CSREF should be close to the controller. The temperature compensating thermistor should be placed as close as possible to the inductor. The wiring path should be kept as short as possible and well away from the switch node.

- Compensation Network: The small feedback cap from COMP to FB should be as close to the controller as possible. Keep the FB traces short to minimize their capacitance to ground.
- **SVID Bus:** The Serial VID bus is a high speed data bus and the bus routing should be done to limit noise coupling from the switching node. The signals should be routed with the Alert# line in between the SVID clock and SVID data lines. The SVID lines must be ground referenced and each line's width and spacing should be such that they have nominal 50 Ω impedance with the board stackup.

Thermal Layout Considerations

Good thermal layout helps high power dissipation from a small package with reduced temperature rise. Thermal layout guidelines are:

- The exposed pads must be well soldered on the board.
- A four or more layers PCB board with solid ground planes is preferred for better heat dissipation.
- More free vias are welcome to be around IC and underneath the exposed pads to connect the inner ground layers to reduce thermal impedance.
- Use large area copper pour to help thermal conduction and radiation.
- Do not put the inductor to be too close to the IC, thus the heat sources are distributed.

PACKAGE DIMENSIONS





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